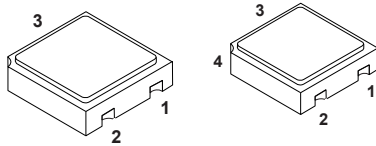
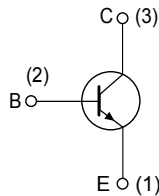


Rad-Hard 50 V, 0.8 A NPN transistor


LCC-3
UB

Pin 4 in UB is connected to the metallic lid.



DS10450

Features

V_{ce0}	$I_C(\text{max.})$	H_{FE} at 10 V, 150 mA	$T_j(\text{max.})$
50 V	0.8 A	> 100	200 °C

- Hermetic packages
- ESCC and JANS qualified
- Up to 100 krad(Si) low dose rate

Description

The **2N2222AHR** is a silicon planar NPN transistor specifically designed and housed in hermetic packages for aerospace and Hi-Rel applications. It is available in the JAN qualification system (MIL-PRF19500 compliance) and in the ESCC qualification system (ESCC 5000 compliance). In case of discrepancies between this datasheet and the relevant agency specification, the latter takes precedence.

Product summary

Product summary				
Part-number	Qualification system	Agency specification	Package	Radiation level
JANSR2N2222AUBx	JANSR	MIL-PRF-19500/255	UB	100 krad
JANS2N2222AUBx	JANS	MIL-PRF-19500/255	UB	-
2N2222ARUBx	ESCC Flight	5201/002	UB	100 krad
2N2222AUBx	ESCC Flight	5201/002	UB	-
SOC2222ARHRx	ESCC Flight	5201/002	LCC-3	100 krad
SOC2222AHRx	ESCC Flight	5201/002	LCC-3	-

Note: See [Table 9](#) for ordering information.

Product status link

[2N2222AHR](#)

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter		Value	Unit
V_{CBO}	Collector-base voltage ($I_E = 0$)		75	V
V_{CEO}	Collector-emitter voltage ($I_B = 0$)		50	V
V_{EBO}	Emitter-base voltage ($I_C = 0$)		6	V
I_C	Collector current		0.8	A
P_{TOT}	Total dissipation at $T_{amb} \leq 25\text{ °C}$	ESCC	0.5	W
		LCC-3 and UB		
		LCC-3 and UB ⁽¹⁾	0.73	
	JANS: UB	0.5		
	Total dissipation at $T_{SP(IS)} = 25\text{ °C}$	JANS: UB	1	W
T_{OP}	Operating temperature range		-65 to 200	°C
T_J	Max. operating junction temperature		200	°C

1. When mounted on a 15 x 15 x 0.6 mm ceramic substrate.

Table 2. Thermal data

Symbol	Parameter	LCC-3 and UB Value	Unit
$R_{thJSP(IS)}$	Thermal resistance junction-solder pad (infinite sink) (max) for JANS	90	°C/W
R_{thJA}	Thermal resistance junction-ambient (max) for JANS	325	
	Thermal resistance junction-ambient (max) for ESCC	350 240 ⁽¹⁾	

1. When mounted on a 15 x 15 x 0.6 mm ceramic substrate.

2 Electrical characteristics

JANS and ESCC version of the products are assembled and tested in compliance with the agency specification. The electrical characteristics of each version are provided in dedicated tables.

2.1 JANS electrical characteristics

Table 3. Electrical characteristics ($T_{amb} = 25\text{ °C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Max.	Unit
I_{CBO}	Collector-base cut-off current ($I_E = 0$)	$V_{CB} = 75\text{ V}$		10	μA
		$V_{CB} = 60\text{ V}$		10	nA
		$V_{CB} = 60\text{ V}, T_{amb} = 150\text{ °C}$		10	μA
I_{CES}	Collector-base cut-off current ($I_E = 0$)	$V_{CE} = 50\text{ V}$		50	nA
I_{EBO}	Emitter-base cut-off current ($I_C = 0$)	$V_{EB} = 6\text{ V}$		10	μA
		$V_{EB} = 4\text{ V}$		10	nA
$V_{(BR)CEO}^{(1)}$	Collector-emitter breakdown voltage ($I_B = 0$)	$I_C = 10\text{ mA}$	50		V
$V_{CE(sat)}^{(1)}$	Collector-emitter saturation voltage	$I_C = 150\text{ mA}, I_B = 15\text{ mA}$		0.3	V
		$I_C = 500\text{ mA}, I_B = 50\text{ mA}$		1	V
$V_{BE(sat)}^{(1)}$	Base-emitter saturation voltage	$I_C = 150\text{ mA}, I_B = 15\text{ mA}$	0.6	1.2	V
		$I_C = 500\text{ mA}, I_B = 50\text{ mA}$		2	V
$h_{FE}^{(1)}$	DC current gain	$I_C = 0.1\text{ mA}, V_{CE} = 10\text{ V}$	50		
		$I_C = 1\text{ mA}, V_{CE} = 10\text{ V}$	75	325	
		$I_C = 10\text{ mA}, V_{CE} = 10\text{ V}$	100		
		$I_C = 150\text{ mA}, V_{CE} = 10\text{ V}$	100	300	
		$I_C = 500\text{ mA}, V_{CE} = 10\text{ V}$	30		
		$I_C = 10\text{ mA}, T_{amb} = -55\text{ °C}, V_{CE} = 10\text{ V}$	35		
h_{fe}	Small signal current gain	$I_C = 20\text{ mA}, f = 100\text{ MHz}, V_{CE} = 20\text{ V}$	2.5		
		$I_C = 1\text{ mA}, f = 1\text{ kHz}, V_{CE} = 10\text{ V}$	50		
C_{OBO}	Output capacitance, ($I_E = 0$)	$100\text{ kHz} \leq f \leq 1\text{ MHz}, V_{CB} = 10\text{ V}$		8	pF
C_{IBO}	Input capacitance, ($I_C = 0$)	$100\text{ kHz} \leq f \leq 1\text{ MHz}, V_{EB} = 0.5\text{ V}$		25	pF
t_{on}	Turn-on time	$I_{CC} = 150\text{ mA}, I_{B1} = 15\text{ mA}, V_{CC} = 30\text{ V}$		35	ns
t_{off}	Turn-off time	$I_{CC} = 150\text{ mA}, I_{B1} = I_{B2} = 15\text{ mA}, V_{CC} = 30\text{ V}$		300	ns

1. Pulsed duration = 300 μs , duty cycle $\leq 1.5\%$

2.2 ESCC electrical characteristics

Table 4. Electrical characteristics ($T_{amb} = 25\text{ °C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Max.	Unit
I_{CBO}	Collector-base cut-off current ($I_E = 0$)	$V_{CB} = 60\text{ V}$		10	nA
		$V_{CB} = 60\text{ V}, T_{amb} = 150\text{ °C}$		10	μA
I_{EBO}	Emitter-base cut-off current ($I_C = 0$)	$V_{EB} = 3\text{ V}$		10	nA
$V_{(BR)CBO}$	Collector-base breakdown voltage ($I_E = 0$)	$I_C = 100\text{ }\mu\text{A}$	75		V
$V_{(BR)CEO}^{(1)}$	Collector-emitter breakdown voltage ($I_B = 0$)	$I_C = 10\text{ mA}$	50		V
$V_{(BR)EBO}$	Emitter-base breakdown voltage ($I_C = 0$)	$I_C = 100\text{ }\mu\text{A}$	6		V
$V_{CE(sat)}^{(1)}$	Collector-emitter saturation voltage	$I_C = 150\text{ mA}, I_B = 15\text{ mA}$		0.3	V
$V_{BE(sat)}^{(1)}$	Base-emitter saturation voltage	$I_C = 150\text{ mA}, I_B = 15\text{ mA}$		1.2	V
$h_{FE}^{(1)}$	DC current gain	$I_C = 0.1\text{ mA}, V_{CE} = 10\text{ V}$	35		
		$I_C = 10\text{ mA}, V_{CE} = 10\text{ V}$	75		
		$I_C = 150\text{ mA}, V_{CE} = 10\text{ V}$	100	300	
		$I_C = 500\text{ mA}, V_{CE} = 10\text{ V}$	40		
		$I_C = 10\text{ mA}, T_{amb} = -55\text{ °C}, V_{CE} = 10\text{ V}$	35		
h_{fe}	Small signal current gain	$I_C = 20\text{ mA}, f = 100\text{ MHz}, V_{CE} = 20\text{ V}$	2.5		
C_{OBO}	Output capacitance ($I_E = 0$)	$100\text{ kHz} \leq f \leq 1\text{ MHz}, V_{CB} = 10\text{ V}$		8	pF
t_{on}	Turn-on time	$I_{CC} = 150\text{ mA},$ $I_{B1} = 15\text{ mA},$ $V_{CC} = 30\text{ V}$		35	ns
t_{off}	Turn-off time	$I_{CC} = 150\text{ mA},$ $I_{B1} = I_{B2} = 15\text{ mA},$ $V_{CC} = 30\text{ V}$		285	ns

1. Pulsed duration = 300 μs , duty cycle $\leq 1.5\%$

2.3 Electrical characteristics (curves)

Figure 1. DC current gain

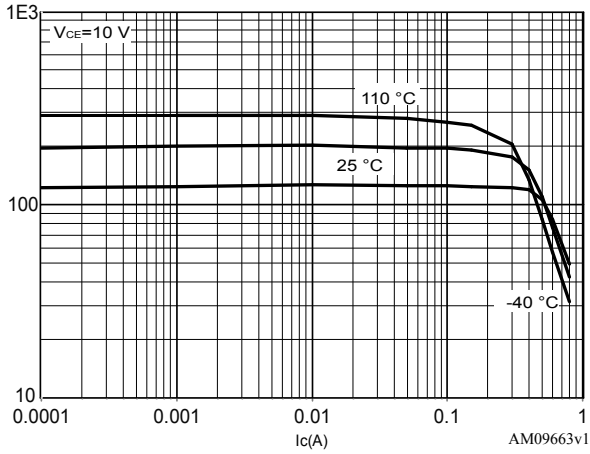


Figure 2. Collector emitter saturation voltage

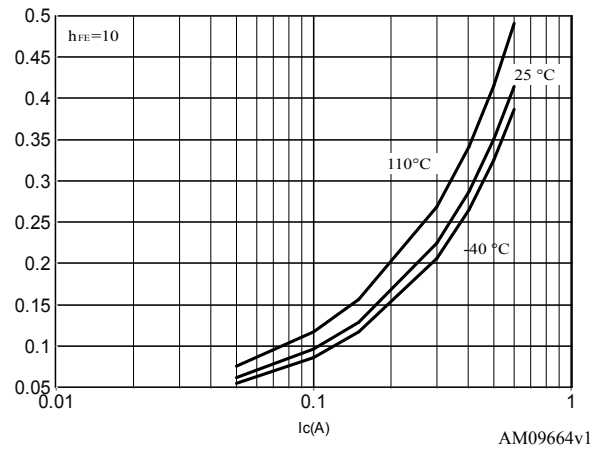
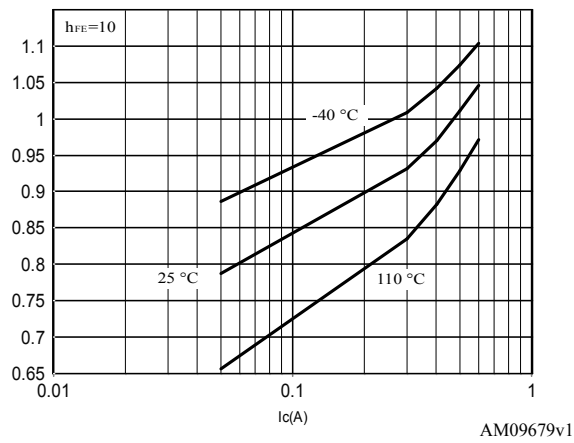
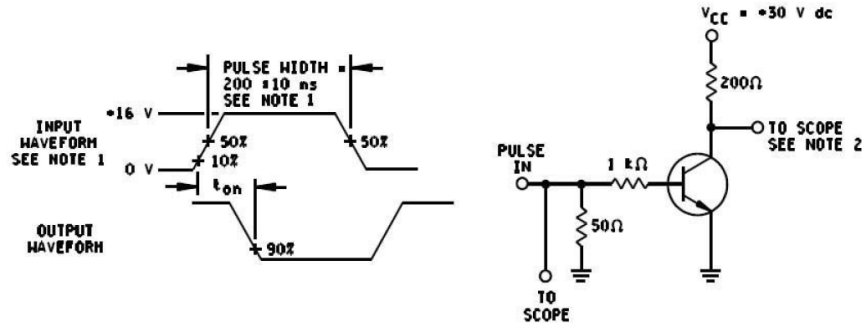


Figure 3. Base emitter saturation voltage



2.4 Test circuits

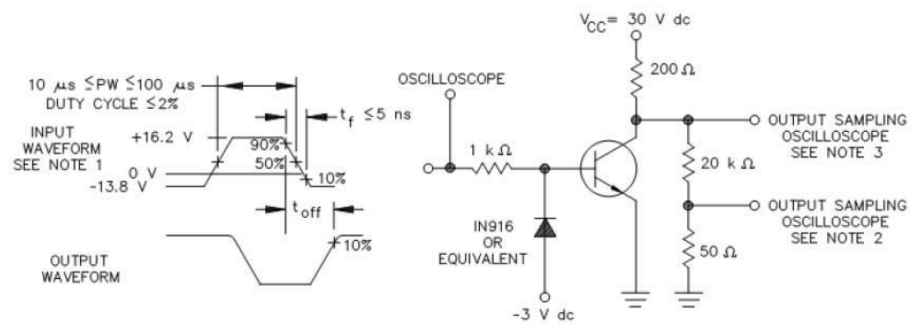
Figure 4. JANS saturated turn-on switching time test circuit



Note: (1) The rise time (t_r) of the applied pulse should be ≤ 2.0 ns, duty cycle ≤ 2 percent, and the generator source impedance shall be 50Ω .

Note: (2) Sampling oscilloscope: $Z_{IN} \geq 100$ k Ω , $C_{IN} \leq 12$ pF, rise time ≤ 5 ns.

Figure 5. JANS saturated turn-off switching time test circuit

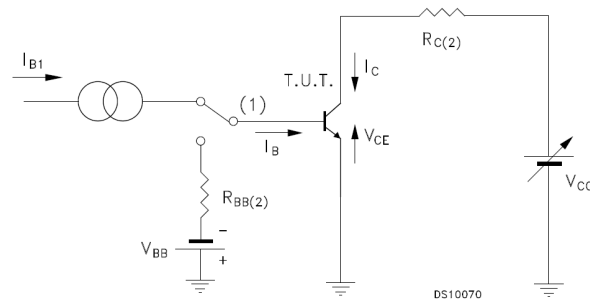


Note: (1) The rise time (t_r) of the applied pulse should be ≤ 2.0 ns, duty cycle ≤ 2 percent, and the generator source impedance shall be 50Ω .

Note: (2) Sampling oscilloscope: $Z_{IN} \geq 100$ k Ω , $C_{IN} \leq 12$ pF, rise time ≤ 5 ns.

Note: (3) Alternate test point for high impedance attenuating probe.

Figure 6. ESCC resistive load switching test circuit



Note: (1) Fast electronic switch

Note: (2) Non-inductive resistor

3 Radiation hardness assurance

3.1 JANS radiation assurance

JANSR2N2222A is guaranteed at 100 krad in compliance with the MIL-PRF-19500, Group D between 50 and 300 rad/s with an additional guarantee at 0.1 rad/s as per ESCC 22900.

Table 5. MIL-PRF-19500 post radiation electrical characteristics ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Max	Unit
I_{CBO}	Collector cut-off current ($I_E = 0$)	$V_{CB} = 75\text{ V}$		20	μA
		$V_{CB} = 60\text{ V}$		20	nA
I_{EBO}	Emitter cut-off current ($I_C = 0$)	$V_{EB} = 6\text{ V}$		20	μA
		$V_{EB} = 4\text{ V}$		20	μA
$V_{(BR)CEO}^{(1)}$	Collector-emitter breakdown voltage ($I_B = 0$)	$I_C = 10\text{ mA}$	50		V
I_{CES}	Collector to emitter cut-off current	$V_{CE} = 50\text{ V}$		100	nA
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_C = 150\text{ mA}, I_B = 15\text{ mA}$		0.35	V
		$I_C = 500\text{ mA}, I_B = 50\text{ mA}$		1.15	
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_C = 150\text{ mA}, I_B = 15\text{ mA}$	0.6	1.38	V
		$I_C = 500\text{ mA}, I_B = 50\text{ mA}$		2.3	
$[hFE]$	Post irradiation gain calculation	$I_C = 0.1\text{ mA}, V_{CE} = 10\text{ V}$	[25] ⁽²⁾		
		$I_C = 1.0\text{ mA}, V_{CE} = 10\text{ V}$	[37.5] ⁽²⁾	325	
		$I_C = 10\text{ mA}, V_{CE} = 10\text{ V}$	[50] ⁽²⁾		
		$I_C = 150\text{ mA}, V_{CE} = 10\text{ V}$	[50] ⁽²⁾	300	
		$I_C = 500\text{ mA}, V_{CE} = 10\text{ V}$	[15] ⁽²⁾		

1. Pulsed duration = 300 μs , duty cycle $\geq 2\%$
2. See method 1019 of MIL-STD-750 for how to determine $[hFE]$ by first calculating the delta ($1/hFE$) from the pre- and Post-radiation hFE . Notice the $[hFE]$ is not the same as hFE and cannot be measured directly. The $[hFE]$ value can never exceed the pre-radiation minimum hFE that it is based upon.

3.2 ESCC radiation assurance

This products is guaranteed in radiation as per ESCC 22900 and in compliance with ESCC 5201/002 specification.

Each lot is tested in radiation according to the following procedure:

- Radiation condition of 0.1 rad (Si)/s.
- Test of 11 samples by wafer, 5 biased at 80% of $V_{(BR)CEO}$, 5 unbiased and for reference.
- Acceptance criteria of each wafer at 100 krad if all 10 samples comply with the post radiation electrical characteristics as per [Table 6](#).

RVT includes the value of each parameter at 30, 50, 70 and 100 krad (Si), post annealing at 24 hour / 25 °C and and post annealing at 168 hours / 100°C.

Table 6. ESCC 5201/002 post radiation electrical characteristics ($T_{amb} = 25\text{ °C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Max	Unit
I_{CBO}	Collector cut-off current ($I_E = 0$)	$V_{CB} = 60\text{ V}$		10	nA
I_{EBO}	Emitter cut-off current ($I_C = 0$)	$V_{EB} = 3\text{ V}$		10	nA
$V_{(BR)CBO}$	Collector-base breakdown voltage ($I_E = 0$)	$I_C = 100\text{ }\mu\text{A}$	75		V
$V_{(BR)CEO}^{(1)}$	Collector-emitter breakdown voltage ($I_B = 0$)	$I_C = 10\text{ mA}$	50		V
$V_{(BR)EBO}$	Emitter-base breakdown voltage ($I_C = 0$)	$I_E = 100\text{ }\mu\text{A}$	6		V
$V_{CE(sat)}^{(1)}$	Collector-emitter saturation voltage	$I_C = 150\text{ mA}$, $I_B = 15\text{ mA}$		0.3	V
$V_{BE(sat)}^{(1)}$	Base-emitter saturation voltage	$I_C = 150\text{ mA}$, $I_B = 15\text{ mA}$		1.2	V
$[h_{FE}]^{(1)}$	Post irradiation gain calculation ⁽²⁾	$I_C = 0.1\text{ mA}$, $V_{CE} = 10\text{ V}$	[17.5]		
		$I_C = 10\text{ mA}$, $V_{CE} = 10\text{ V}$	[37.5]		
		$I_C = 150\text{ mA}$, $V_{CE} = 10\text{ V}$	[50]	300	
		$I_C = 500\text{ mA}$, $V_{CE} = 10\text{ V}$	[20]		

1. Pulsed duration = 300 μs , duty cycle $\geq 2\%$

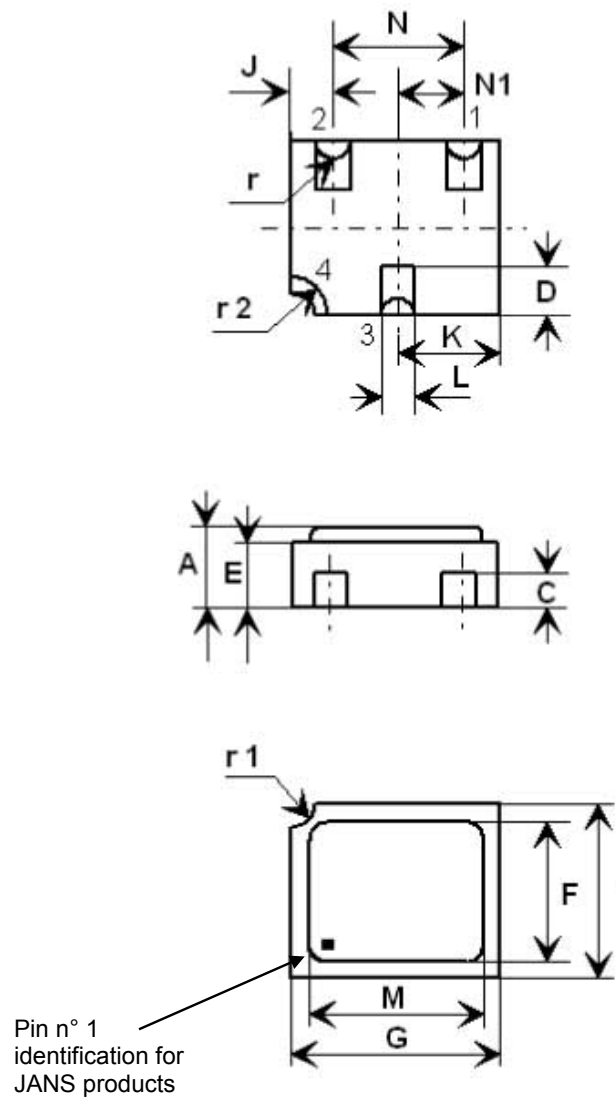
2. The post-irradiation gain calculation of $[h_{FE}]$, made using h_{FE} measurements from prior to and on completion of irradiation testing and after each annealing step if any, shall be as specified in MILSTD-750 method 1019.

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 UB package information

Figure 7. UB package outline



Pad 1: Emitter

Pad 2: Base

Pad 3: Collector

Pad 4: Shielding connected to the lid

8206487 rev.6

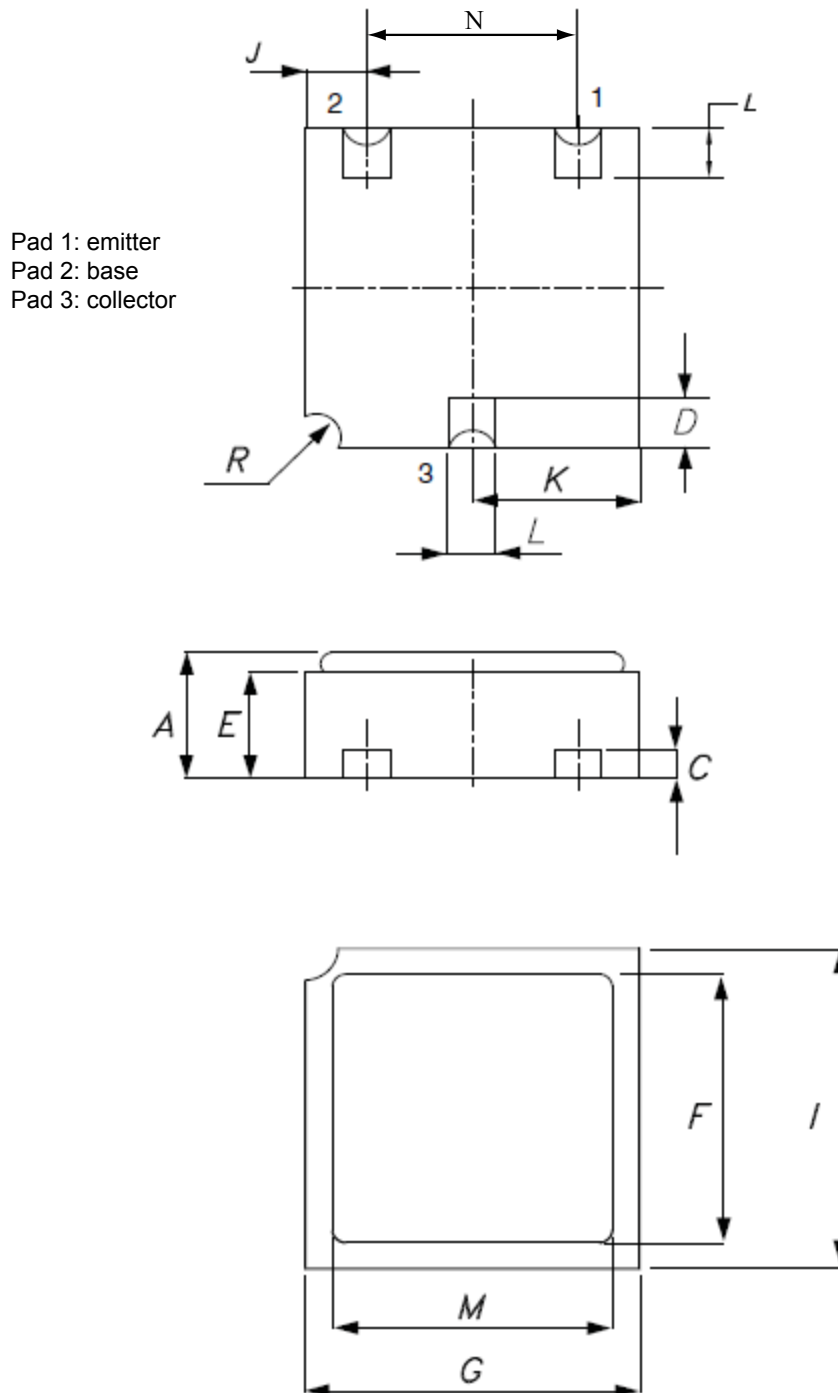
Note: For JANS products: the pin out numbering for emitter and base is inverted (base is designated pin 1 and emitter pin 2)

Table 7. UB package mechanical data

Symbols	Dimensions in mm			Dimensions in inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.16		1.42	0.045		0.056
C	0.46	0.51	0.56	0.018	0.020	0.022
D	0.56	0.76	0.96	0.024	0.030	0.036
E	0.92	1.02	1.12	0.036	0.040	0.044
F	1.95	2.03	2.11	0.077	0.080	0.083
G	2.92	3.05	3.18	0.115	0.120	0.125
I	2.41	2.54	2.67	0.095	0.100	0.105
J	0.42	0.57	0.72	0.0165	0.0225	0.0285
K	1.37	1.52	1.67	0.054	0.060	0.066
L	0.41	0.51	0.61	0.016	0.020	0.024
M	2.46	2.54	2.62	0.097	0.100	0.103
N	1.81	1.91	2.01	0.071	0.075	0.079
N1	0.91	0.96	1.02	0.036	0.038	0.040
r		0.20			0.008	
r1		0.30			0.012	
r2		0.56			0.022	

4.2 LCC-3 package information

Figure 8. LCC-3 package outline



0041211 rev.14

Table 8. LCC-3 package mechanical data

Symbols	Dimensions in mm			Dimensions in inches (for reference only)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.16		1.42	0.046		0.056
C	0.45	0.50	0.56	0.018	0.020	0.022
D	0.60	0.56	0.96	0.024	0.022	0.038
E	0.91	1.01	1.12	0.036	0.040	0.044
F	1.95	2.03	2.11	0.077	0.080	0.083
G	2.92	3.05	3.17	0.115	0.120	0.125
I	2.41	2.54	2.66	0.095	0.100	0.105
J	0.42	0.57	0.72	0.0165	0.0225	0.0285
K	1.37	1.52	1.67	0.054	0.060	0.066
L	0.40	0.50	0.60	0.016	0.020	0.024
M	2.46	2.54	2.62	0.097	0.100	0.103
N	1.80	1.90	2.00	0.071	0.075	0.079
R		0.30			0.012	

5 Ordering information

Table 9. Ordering information

Part number	Agency specification	Quality level	Radiation level ⁽¹⁾	Package	Mass	Lead finish	Marking ⁽²⁾	Packing				
J2N2222AUB1	-	Engineering model JANS	-	UB	0.6 g	Gold	J2222AUB1	WafflePack				
2N2222AUB1	-	Engineering model ESCC	-				2N2222AUB1					
SOC2222A1	-	Engineering model ESCC	-	LCC-3			SOC2222A1					
JANSR2N2222AUBG	MIL-PRF-19500/255	JANSR	100 krad	UB			0.6 g		Solder Dip	JSR2222		
JANSR2N2222AUBT		JANSR	high and low dose rate			JSR2222						
JANS2N2222AUBG		JANS	-			JS2222						
JANS2N2222AUBT		JANS	-			JS2222						
2N2222ARUBG	5201/002/11R	ESCC Flight	100 krad - low dose rate			LCC-3			0.6 g	Gold	520100211R	Tape and reel
2N2222ARUBT	5201/002/12R										520100212R	
2N2222ARUBTW	5201/002/12R		-							520100211		
2N2222AUBG	5201/002/11		-		520100212							
2N2222AUBT	5201/002/12		-		520100204R							
SOC2222ARHRG	5201/002/04R		100 krad - low dose rate		520100205R							
SOC2222ARHRT	5201/002/05R			520100205R								
SOC2222ARHRTW	5201/002/05R		-	520100204								
SOC2222AHRG	5201/002/04		-	520100205								
SOC2222AHRT	5201/002/05		-	520100205								
SOC2222AHRTW	5201/002/05	-	520100205									

1. High dose rate as per MIL-PRF-19500 specification group D, subgroup 2 inspection. Low dose rate as per ESCC specification 22900.

2. Specific marking only. The full marking includes in addition: For the Engineering Models: ST logo, date code; country of origin (FR). For ESCC flight parts: ST logo, date code, country of origin (FR), ESA logo, serial number of the part within the assembly lot.

Contact ST sales office for information about specific conditions for products in die form.



6 Other information

6.1 Traceability information

The date code information is structured as described in the table below.

Table 10. Date codes

Model	Date code
EM	3yywwN
ESCC	yywwN
JANS FLIGHT	WyywwN

1. yy = year, ww = week number, N = lot index in the week.

6.2 Documentation

Table 11. Documentation provided for each type of product

Quality level	Radiation level	Documentation
JANS Flight	-	Certificate of conformance
JANSR Flight	100 krad	Certificate of conformance RVT report (50 rad/s and 0.1 rad/s)
Engineering model	-	Certificate of conformance
ESCC	-	Certificate of conformance ESCC qualification maintenance lot reference
ESCC	100 krad	Certificate of conformance ESCC qualification maintenance lot reference Radiation verification test (RVT) report at 25 / 50 / 70 / 100 krad at 0.1 rad / s.

Revision history

Table 12. Document revision history

Date	Revision	Changes
04-Jan-2010	1	Initial release.
16-Apr-2010	2	Added Table 1 on page 1.
09-Jul-2010	3	Modified: Table 1 on page 1 and Table 12 on page 18.
30-Nov-2011	4	<ul style="list-style-type: none"> – Modified: Table 5 on page 5. – Added: Section 2.3: Electrical characteristics (curves). – Modified: Table 1 and 2; – Added: Table 2, 11, 12. – Minor text changes in the document title and description on the cover page.
12-Dec-2011	5	Minor text changes to improve readability;
17-Apr-2012	6	<p>Updated:</p> <ul style="list-style-type: none"> – Title and description in cover page. – PTOT in Table 2: Absolute maximum ratings. – The entire Section 2: Electrical characteristics. <p>Added:</p> <ul style="list-style-type: none"> – Table 3: Thermal data, Section 3: Radiation hardness assurance and Table 13: Ordering information. – Figure 7: JANS saturated turn-on switching time test circuit and Figure 8: JANS saturated turn-off switching time test circuit. – Section 6: Shipping details.
19-Apr-2012	7	Updated titles in Figure 7: JANS saturated turn-on switching time test circuit and Figure 8: JANS saturated turn-off switching time test circuit.
24-Apr-2012	8	Updated R_{thJA} value in Table 3: Thermal data.
14-May-2012	9	Updated Table 13: Ordering information.
21-Feb-2013	10	Table 1: Device summary and Table 13: Ordering information have been updated. Updated text in Section 3: Radiation hardness assurance.
04-Apr-2013	11	Inserted Table 7: Radiation summary.
06-Jun-2013	12	Updated package name for UB.
18-Sep-2013	13	Table 1: Device summary and Table 13: Ordering information have been updated.
25-Mar-2014	14	Table 1: Device summary and Table 13: Ordering information have been updated. Updated Section 3: Radiation hardness assurance and Section 4: Package mechanical data. Inserted Figure 2: Safe operating area for LCC-3 and UB and Figure 3: Safe operating area for TO-18.
01-Apr-2014	15	Modified note in package silhouette on cover page.
29-May-2014	16	Updated Table 1: Device summary and Table 13: Ordering information.
17-Feb-2015	17	Updated Table 1.: Device summary. Minor text changes.
27-Feb-2015	18	Minor text changes.
05-May-2015	19	Updated Table 1.: Device summary. Minor text changes.
21-Aug-2015	20	Updated: Section 4.3: TO-18 package information. Minor text changes.
02-Apr-2020	21	Removed TO-18 package information. Minor text changes.
10-Jun-2020	22	Modified title and features table on cover page. Minor text changes.

Date	Revision	Changes
02-Feb-2021	23	Updated functional schematic. Updated Table 1 , Table 9 and Section 6.2 . Removed STPOWER logo and Radiation summary table.

Contents

1	Electrical ratings	2
2	Electrical characteristics	3
2.1	JANS electrical characteristics	3
2.2	ESCC electrical characteristics	4
2.3	Electrical characteristics (curves)	5
2.4	Test circuits	6
3	Radiation hardness assurance	7
3.1	JANS radiation assurance	7
3.2	ESCC radiation assurance	8
4	Package information	9
4.1	UB package information	9
4.2	LCC-3 package information	11
5	Ordering information	13
6	Other information	14
6.1	Traceability information	14
6.2	Documentation	14
	Revision history	15

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